



SGM48017C/SGM48018C/SGM48019C Power MOSFET and IGBT Gate Drivers with Comprehensive Protections

GENERAL DESCRIPTION

The SGM48017C/18C/19C are high-speed gate drivers capable of effectively driving MOSFET and IGBT power switches. They allow for up to 8A source and 13A sink peak currents at $V_{DD} = 20V$. The SGM48017C/18C/19C provide a set of comprehensive protection features such as thermal shutdown protection and under-voltage lockout. They operate with a wide supply range of 4.5V to 20V.

The SGM48017C/18C/19C are available in a Green SOT-23-5 package. They operate over a temperature range of $-40^{\circ}C$ to $+125^{\circ}C$.

APPLICATIONS

Power MOSFETs
IGBT Driving for Power Supplies
Motor Drivers

FEATURES

- Simple and Reliable
- 8A Source and 13A Sink Peak Currents
- Wide Supply Voltage Range: 4.5V to 20V
- Fast Propagation Delay: 30ns (TYP)
- Fast Rise Time: 7ns (TYP)
- Fast Fall Time: 8ns (TYP)
- Ringing Suppression
- Negative Voltage Capability on INx Pin:
-10V when $(V_{DD} - V_{INx}) \leq 22V$
- Negative Voltage Capability on EN Pin:
-10V when $(V_{DD} - V_{EN}) \leq 22V$
- Negative Voltage Capability on OUT Pin:
-5V (Pulse < 500ns)
- Protection Features
 - Thermal Shutdown Protection
 - Under-Voltage Lockout
- $-40^{\circ}C$ to $+125^{\circ}C$ Operating Temperature Range
- Available in a Green SOT-23-5 Package

TYPICAL APPLICATIONS

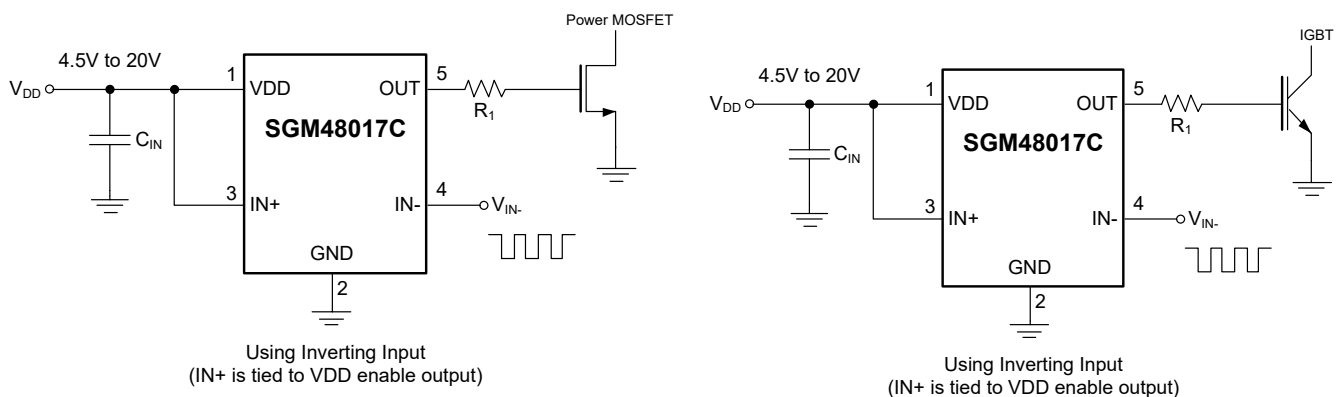


Figure 1. Typical Application Circuits

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM48017C	SOT-23-5	-40°C to +125°C	SGM48017CXN5G/TR	03JXX	Tape and Reel, 3000
SGM48018C	SOT-23-5	-40°C to +125°C	SGM48018CXN5G/TR	03KXX	Tape and Reel, 3000
SGM48019C	SOT-23-5	-40°C to +125°C	SGM48019CXN5G/TR	03LXX	Tape and Reel, 3000

MARKING INFORMATION

NOTE: XX = Date Code.

YYY X X

— Date Code - Week
 — Date Code - Year
 — Serial Number

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

VDD -0.3V to 22V
 Continuous INx, when (VDD - VINx) ≤ 22V
 -10V to VDD + 0.3V
 Continuous EN, when (VDD - VEN) ≤ 22V
 -10V to VDD + 0.3V
 Continuous OUT (DC)..... -0.3V to VDD + 0.3V
 Pulse OUT (Pulse < 500ns) -5V to VDD + 0.3V
 Power Dissipation, PD @ TA = +25°C
 SOT-23-5 0.67W
 Package Thermal Resistance
 SOT-23-5, θJA 185°C/W
 Junction Temperature +150°C
 Storage Temperature Range..... -65°C to +150°C
 Lead Temperature (Soldering, 10s)..... +260°C
 ESD Susceptibility
 HBM..... 8000V
 CDM 1000V

RECOMMENDED OPERATING CONDITIONS

Supply Voltage Range 4.5V to 20V
 Operating Junction Temperature -40°C to +125°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

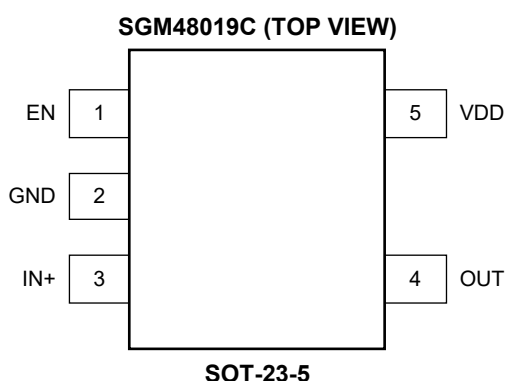
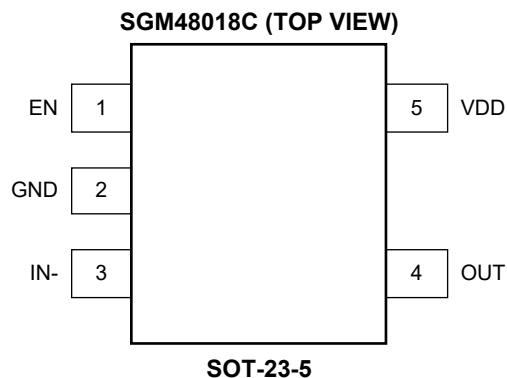
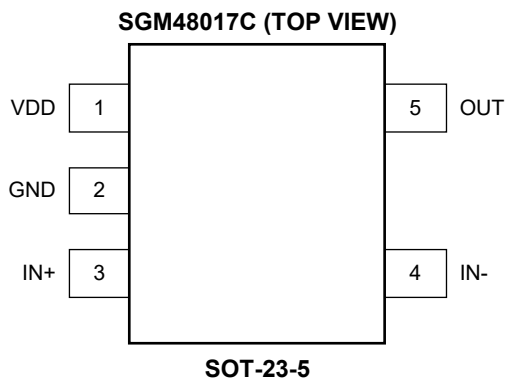
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS



PIN DESCRIPTION

PIN			NAME	I/O	FUNCTION
SGM48017C	SGM48018C	SGM48019C			
1	5	5	VDD	P	Supply Input. Place a 4.7μF decoupling capacitor between this pin and GND pin close to the device.
2	2	2	GND	G	Ground. All signals are referenced to this pin.
3	—	3	IN+	I	Non-Inverting Input. OUT is held low if IN+ is floating. For the SGM48017C, when the driver is used in inverting configuration, pull IN+ high in order to enable output.
4	3	—	IN-	I	Inverting Input. OUT is held low if IN- is floating. For the SGM48017C, when the driver is used in non-inverting configuration, pull IN- low in order to enable output.
5	4	4	OUT	O	Source/Sink Current Output of Driver.
—	1	1	EN	I	Enable Input. EN is biased low to disable output regardless of input state. EN is biased high or left floating to enable output. EN is allowed to float.

NOTE:

P: power supply, I: input, O: output, G: ground.

ELECTRICAL CHARACTERISTICS

($V_{DD} = 12V$, $C_{IN} = 4.7\mu F$, typical values are at $T_J = +25^\circ C$, $T_J = -40^\circ C$ to $+125^\circ C$, unless otherwise noted.)

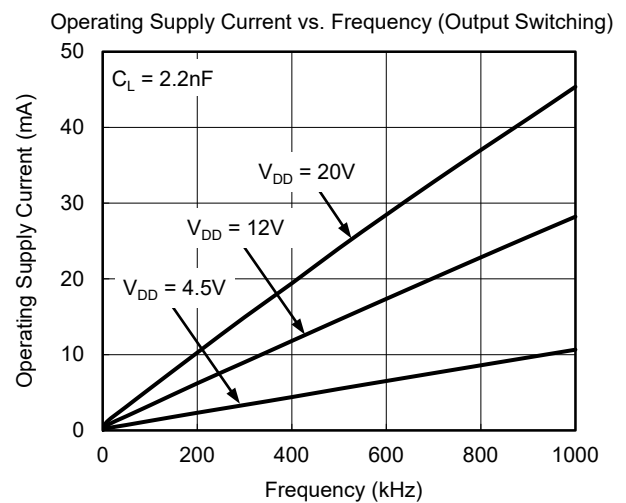
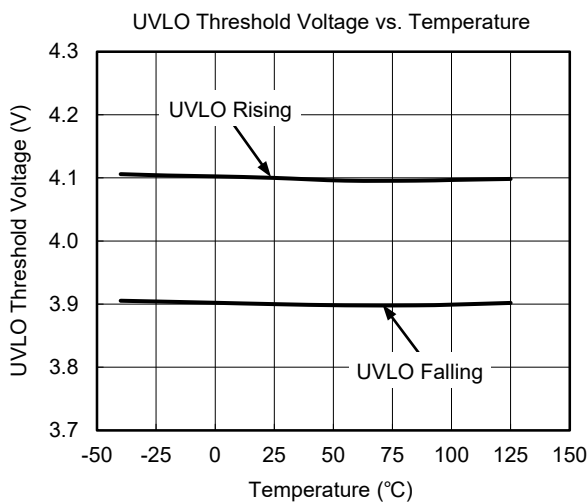
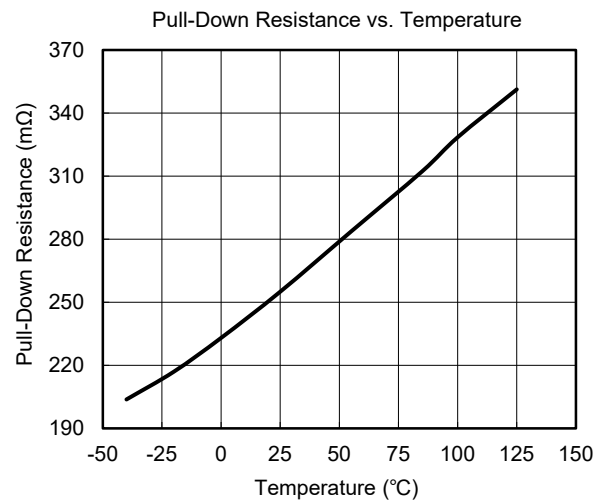
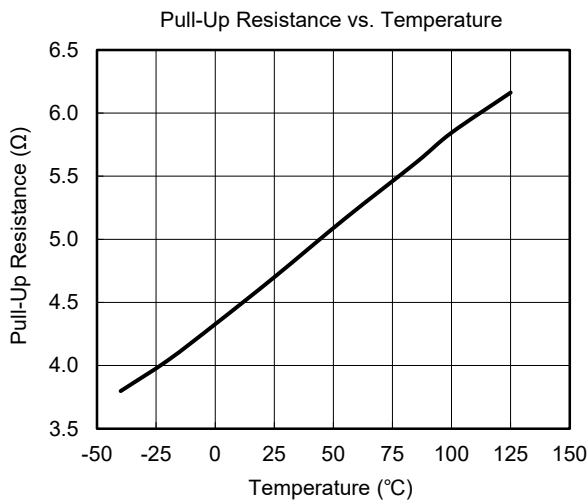
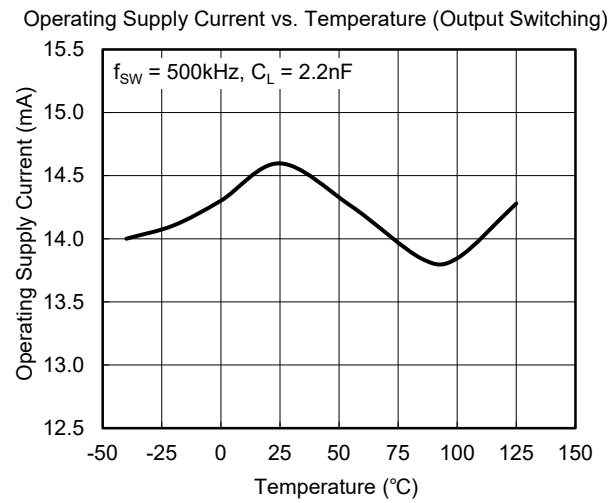
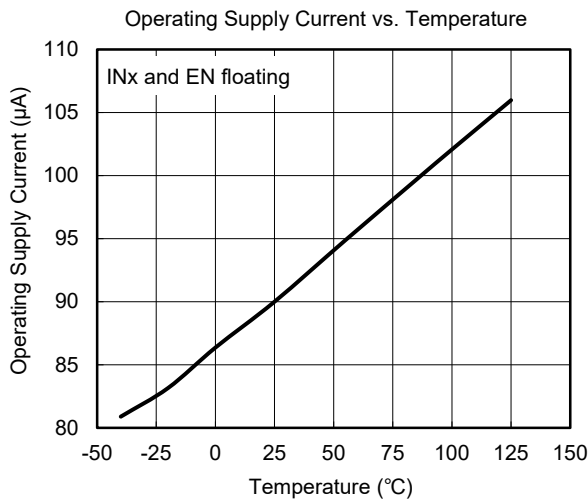
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Power Supplies						
VDD Operating Supply Voltage	V _{DD}		4.5		20	V
VDD Operating Supply Current	I _{VDD}	INx, EN floating, T _J = +25°C		90	120	μA
		V _{IN+} = 5V, V _{IN-} = 0V, SGM48017C only, T _J = +25°C		750	960	
		V _{EN} = 5V, V _{IN-} = 0V, SGM48018C only, T _J = +25°C		815	1040	
		V _{EN} = 5V, V _{IN+} = 5V, SGM48019C only, T _J = +25°C		775	990	
VDD Under-Voltage Lockout Voltage	V _{UVLO}	V _{DD} rising	3.8	4.1	4.4	V
VDD Under-Voltage Lockout Voltage Hysteresis	V _{HYS}			200		mV
Inputs (INx, EN)						
Input Low Voltage	V _{IL}				0.7	V
Input High Voltage	V _{IH}		2.5			V
Input Low Current	I _{IL}	Inverting input current, V _{INx} = 0V, T _J = +25°C		110	140	μA
		Non-inverting input current, V _{INx} = 0V, T _J = +25°C		0.1	1	
Input High Current	I _{IH}	Inverting input current, V _{INx} = 20V, T _J = +25°C		0.2	2	μA
		Non-inverting input current, V _{INx} = 20V, T _J = +25°C		115	150	
EN Low Current	I _{ENL}	V _{EN} = 0V, T _J = +25°C		110	145	μA
EN High Current	I _{ENH}	V _{EN} = 20V, T _J = +25°C		0.2	2	μA
Outputs						
Pull-Up Resistance ⁽¹⁾	R _{OH}	V _{DD} = 12V, I _{OUT_SOURCE} = 50mA		4.7	7.4	Ω
		V _{DD} = 4.5V, I _{OUT_SOURCE} = 50mA		5.3	8.3	
Pull-Down Resistance	R _{OL}	V _{DD} = 12V, I _{OUT_SINK} = -50mA		255	440	mΩ
		V _{DD} = 4.5V, I _{OUT_SINK} = -50mA		265	460	
Peak Output Current	I _{PK_SOURCE}	V _{DD} = 20V, C _L = 0.22μF, f _{SW} = 1kHz		8		A
	I _{PK_SINK}			13		A
Switching Characteristics						
Rise Time	t _R	C _L = 2.2nF, see Figure 2 through Figure 9		7		ns
Fall Time	t _F			8		ns
Propagation Delay (IN+) to OUT	t _{D1}	C _L = 2.2nF, 3V input pulse, see Figure 2, Figure 4 and Figure 8		26		ns
	t _{D2}			30		ns
Propagation Delay (IN-) to OUT	t _{D3}	C _L = 2.2nF, 3V input pulse, see Figure 3, Figure 5 and Figure 6		30		ns
	t _{D4}			26		ns
Propagation Delay (EN) to OUT	t _{D5}	C _L = 2.2nF, 3V input pulse, see Figure 7 and Figure 9		26		ns
	t _{D6}			30		ns
Protection Circuits						
Thermal Shutdown Temperature	T _{TSD}			165		°C
Thermal Shutdown Temperature Hysteresis	T _{HYS}			30		°C

NOTE:

1. R_{OH} represents constant pull-up resistance only. Pull-up resistance R_{OH_PULSE} operates in pulse mode during the output rising stage, $R_{OH_PULSE} = 565m\Omega$ (TYP).

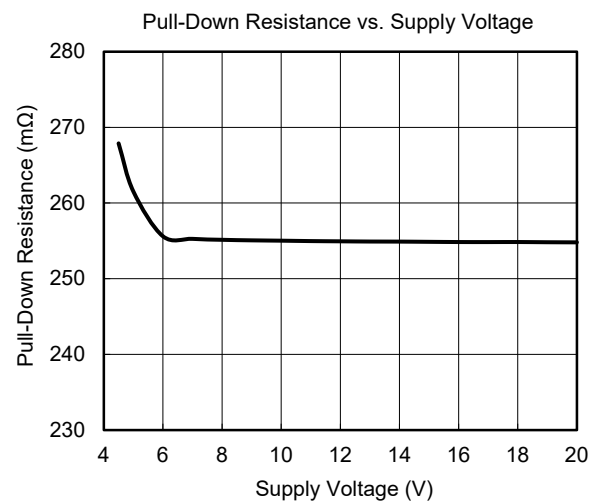
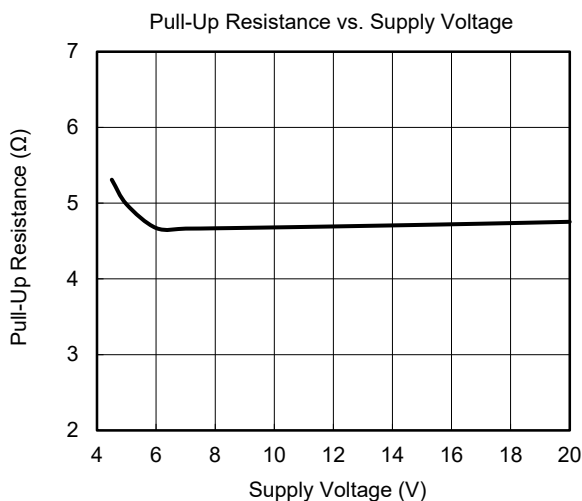
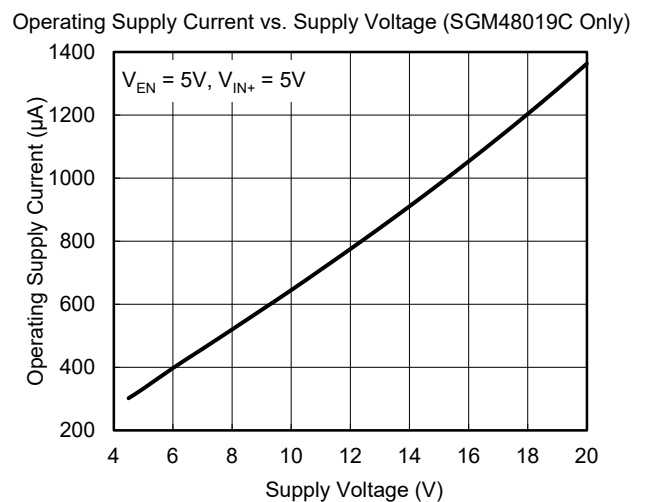
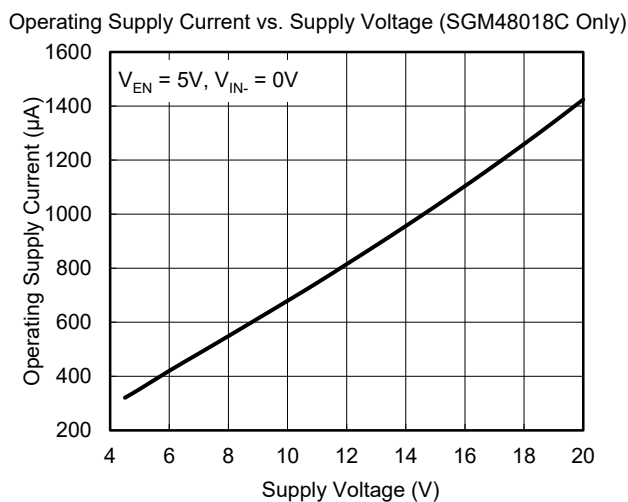
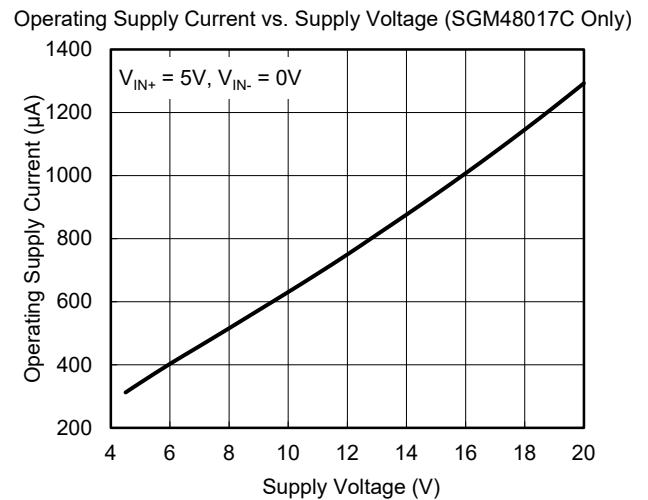
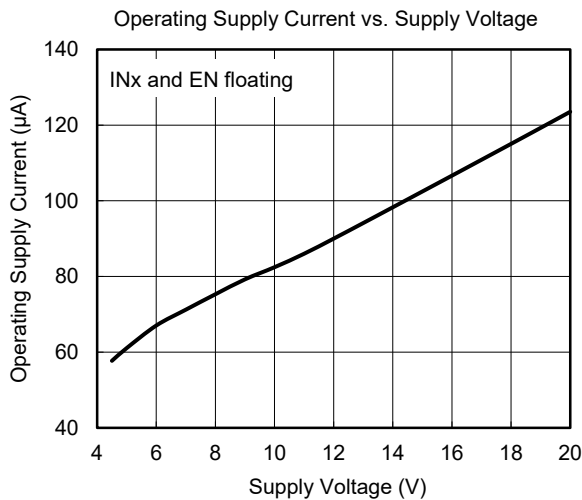
TYPICAL PERFORMANCE CHARACTERISTICS

At $T_J = +25^\circ\text{C}$, $V_{DD} = 12\text{V}$, $C_{IN} = 4.7\mu\text{F}$, unless otherwise noted.



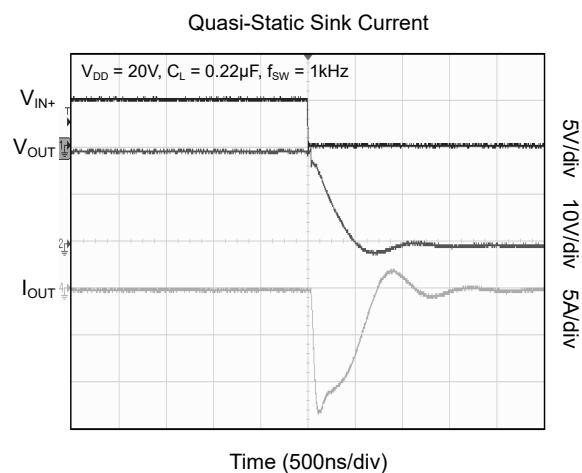
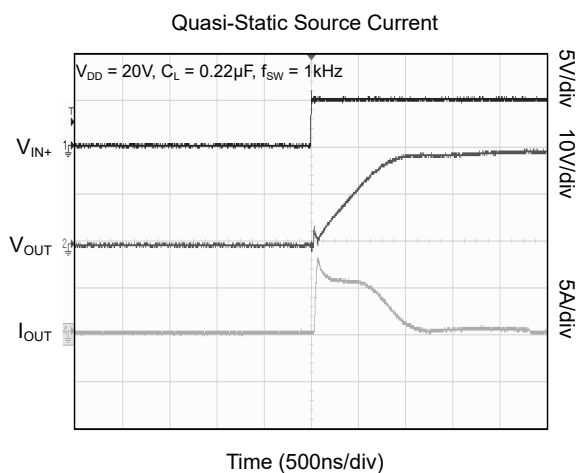
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At $T_J = +25^\circ\text{C}$, $V_{DD} = 12\text{V}$, $C_{IN} = 4.7\mu\text{F}$, unless otherwise noted.



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At $T_J = +25^\circ\text{C}$, $V_{DD} = 12\text{V}$, $C_{IN} = 4.7\mu\text{F}$, unless otherwise noted.



TIMING DIAGRAMS

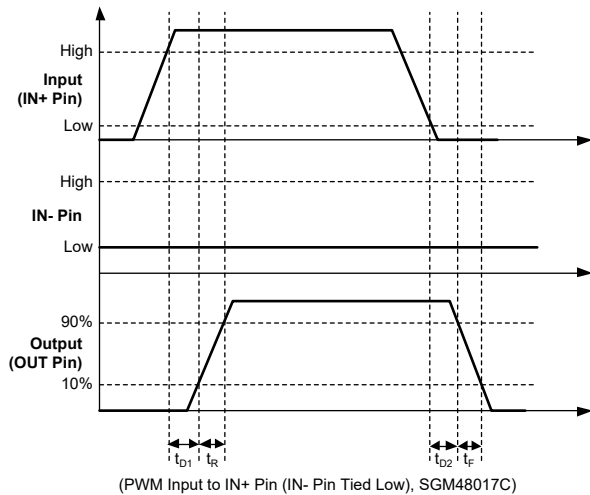


Figure 2. Non-Inverting Configuration

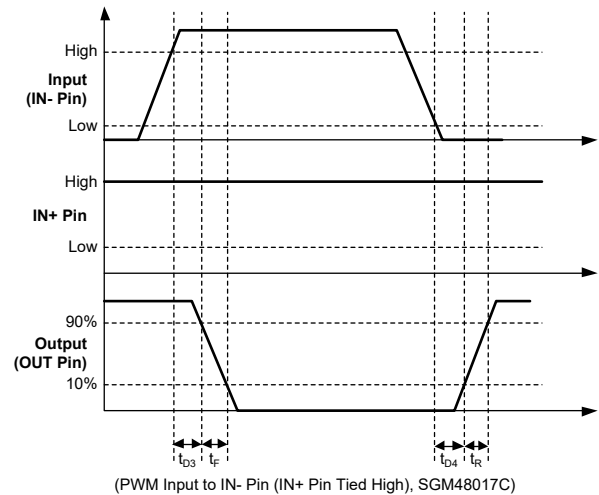


Figure 3. Inverting Configuration

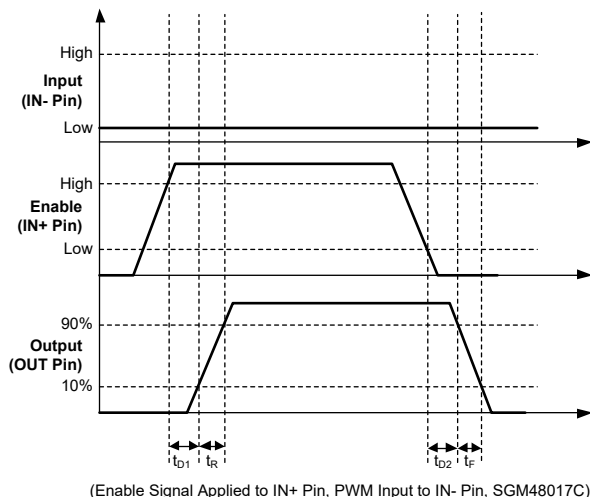


Figure 4. Enable and Disable Functions Using IN+ Pin

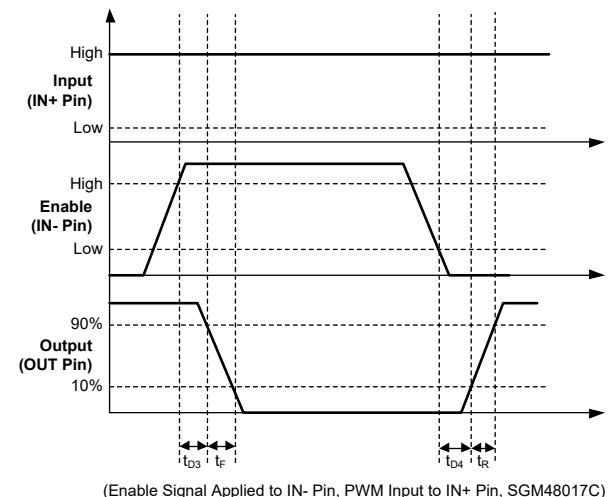


Figure 5. Enable and Disable Functions Using IN- Pin

TIMING DIAGRAMS (continued)

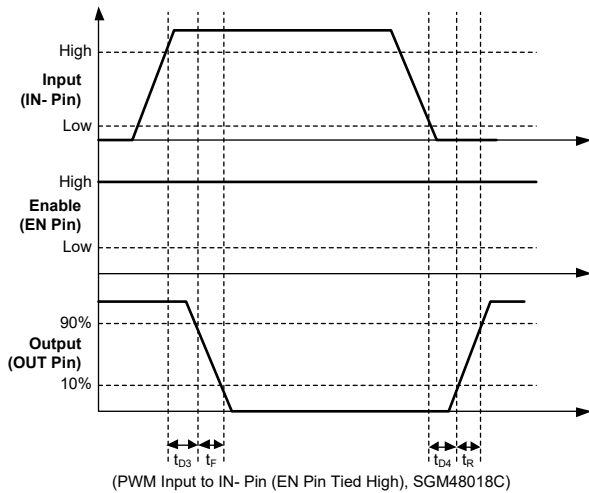


Figure 6. Inverting Configuration

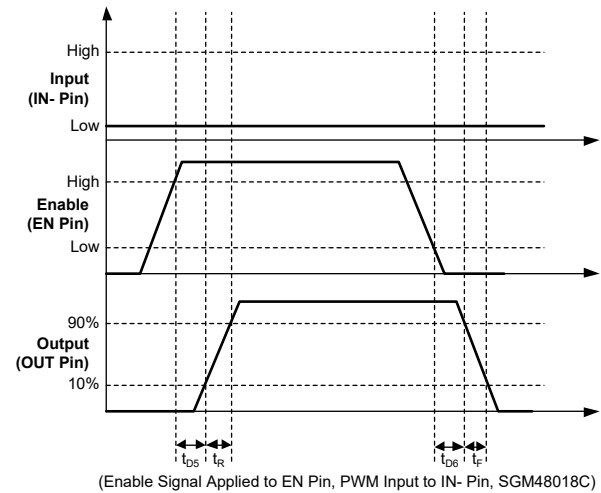


Figure 7. Enable and Disable Functions Using EN Pin

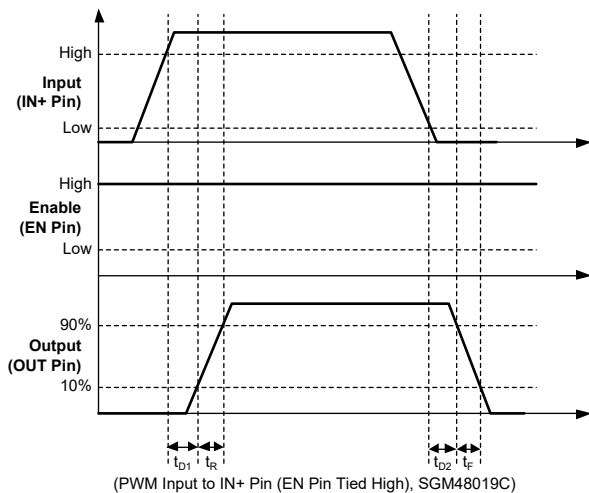


Figure 8. Non-Inverting Configuration

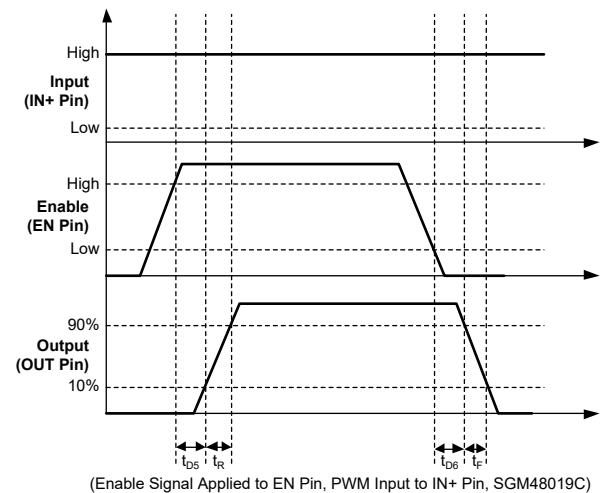


Figure 9. Enable and Disable Functions Using EN Pin

FUNCTION TABLE

SGM48017C			SGM48018C			SGM48019C		
IN+	IN-	OUT	EN	IN-	OUT	EN	IN+	OUT
L	L	L	L	L	L	L	L	L
L	H	L	L	H	L	L	H	L
H	L	H	H	L	H	H	L	L
H	H	L	H	H	L	H	H	H
–	Floating	L	Floating	L	H	Floating	L	L
Floating	–	L	Floating	H	L	Floating	H	H
–	–	–	–	Floating	L	–	Floating	L

FUNCTIONAL BLOCK DIAGRAMS

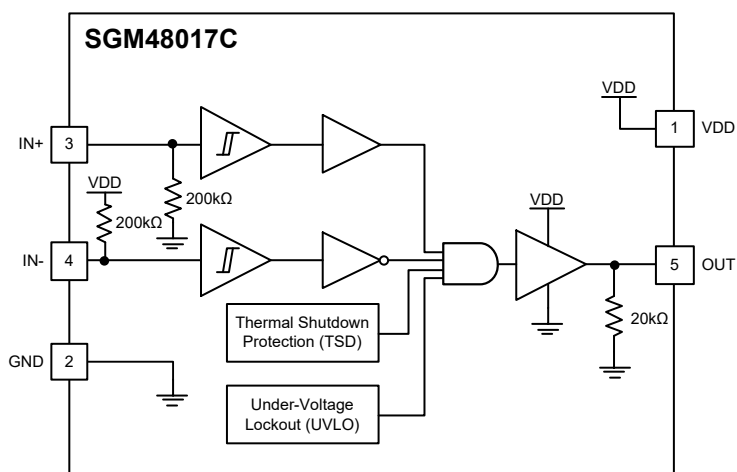


Figure 10. SGM48017C Block Diagram

FUNCTIONAL BLOCK DIAGRAMS (continued)

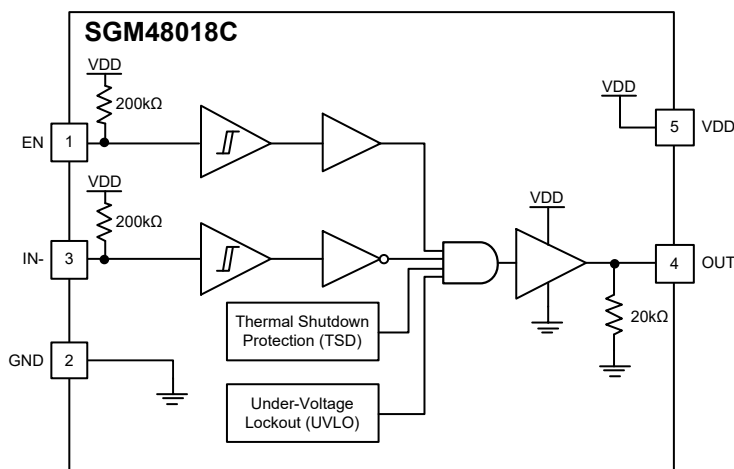


Figure 11. SGM48018C Block Diagram

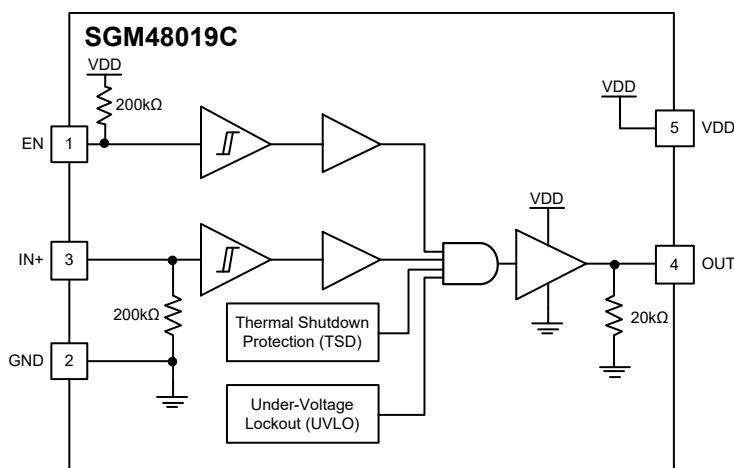


Figure 12. SGM48019C Block Diagram

DETAILED DESCRIPTION

The SGM48017C/18C/19C are reliable and high-speed gate drivers for power MOSFETs and IGBTs with a comprehensive set of protection features such as thermal shutdown protection (TSD) and under-voltage lockout (UVLO). Both TSD and UVLO are active. The output will be forced low when any threshold of the above two protections is reached and held low during

hysteresis range. Only if both TSD and UVLO are released, the output follows the input again.

The SGM48017C/18C/19C offer a unique output stage design. It can effectively suppress the output voltage ringing and the overshoot/undershoot on the outputs.

REVISION HISTORY

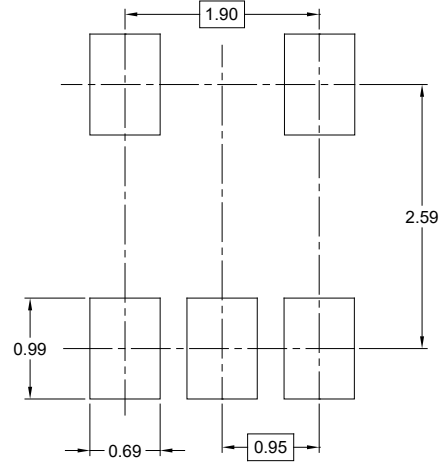
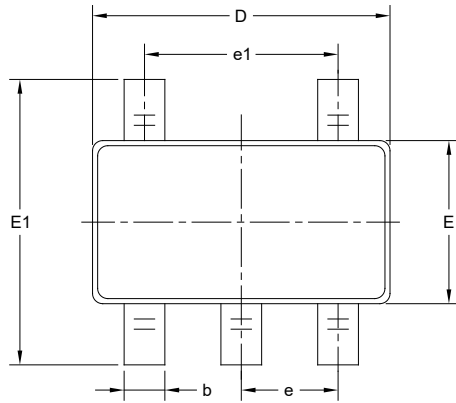
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (MARCH 2023) to REV.A

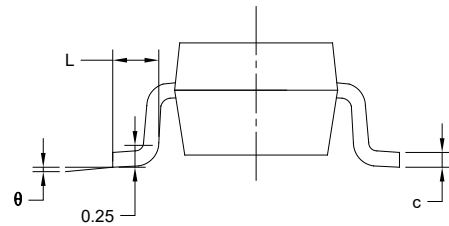
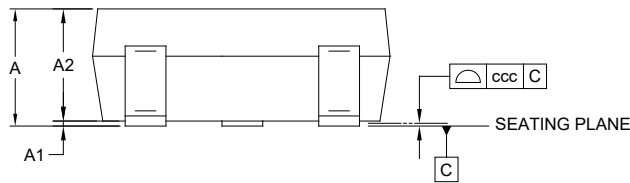
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PACKAGE OUTLINE DIMENSIONS

SOT-23-5



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A	-	-	1.450
A1	0.000	-	0.150
A2	0.900	-	1.300
b	0.300	-	0.500
c	0.080	-	0.220
D	2.750	-	3.050
E	1.450	-	1.750
E1	2.600	-	3.000
e	0.950 BSC		
e1	1.900 BSC		
L	0.300	-	0.600
θ	0°	-	8°
ccc	0.100		

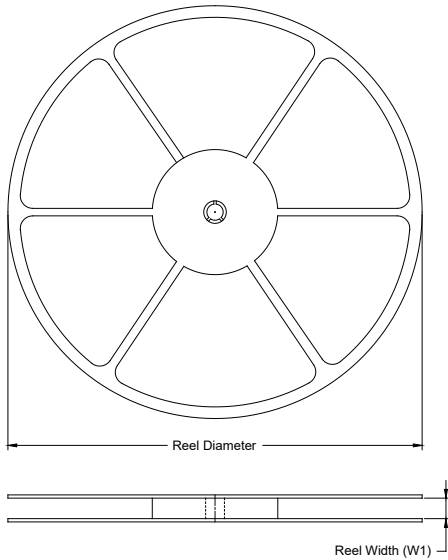
NOTES:

1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MO-178.

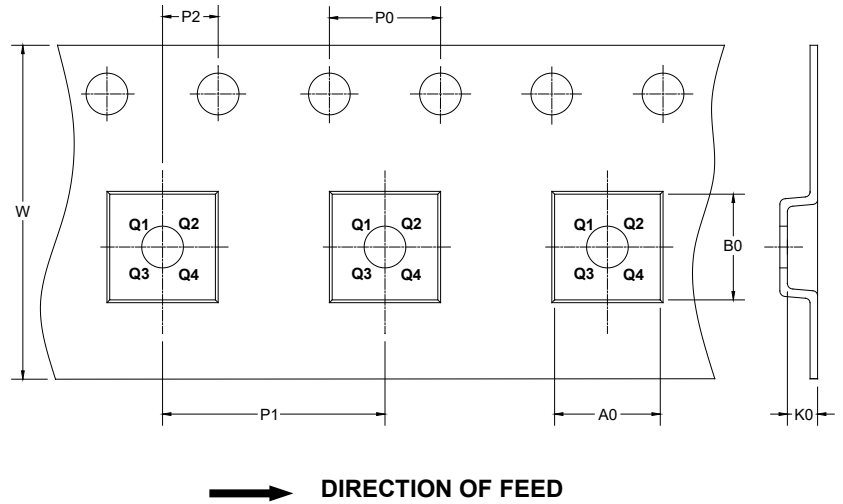
PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

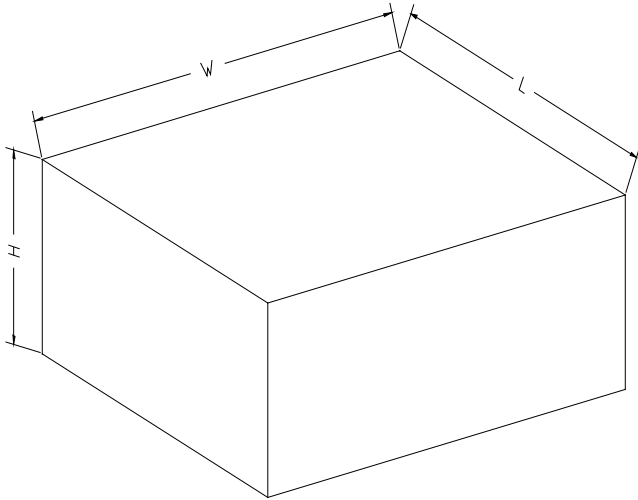
KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3

DD00001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

DD0002